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Amendments to the Claims:

1. (Currently Amended): A plasma enhanced chemical vapor deposition method of forming a titanium silicide-comprising layer over a substrate using a reactive gas comprising TiCl₄ and at least one silane, comprising:

providing a substrate within a plasma enhanced chemical vapor deposition chamber;

with the substrate in the chamber, first feeding TiCl₄ to the chamber without feeding any measurable silane to the chamber for a first period of time; and

after the first feeding for the first period of time, second feeding TiCl₄ and at least one silane to the chamber for a second period of time effective to plasma enhance chemical vapor deposit a titanium silicide-comprising layer onto a conductively doped silicon surface on the substrate <u>received</u> within the chamber during the first feeding.

2. (Original): The method of claim 1 wherein the second feeding occurs at selected chamber deposition pressure and substrate temperature conditions, the first feeding also occurring at the selected second feeding chamber deposition pressure and substrate temperature conditions.

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3. (Original): The method of claim 1 wherein the feeding of TiCl₄ during the first and second feedings is at a substantially constant volumetric flow rate.

- 4. (Original): The method of claim 1 wherein the feeding of TiCl₄ during the first and second feedings is at different volumetric flow rates.
- 5. (Currently Amended): A plasma enhanced chemical vapor deposition method of forming a titanium silicide-comprising layer over a substrate using a reactive gas comprising TiCl₄ and at least one silane, comprising:

providing a substrate within a plasma enhanced chemical vapor deposition chamber;

with the substrate in the chamber, first feeding TiCl₄ to the chamber without feeding any measurable silane to the chamber for a first period of time, and wherein nothing other than TiCl₄ is fed to the chamber during the first period of time; and

after the first feeding for the first period of time, second feeding TiCl₄ and at least one silane to the chamber for a second period of time effective to plasma enhance chemical vapor deposit a titanium silicide-comprising layer on the substrate <u>received within the chamber during the first feeding</u>.

6. (Original): The method of claim 1 wherein the first period of time is less than the second period of time.

 7. (Original): The method of claim 1 wherein the first period of time is no greater than 5 seconds.

- 8. (Original): The method of claim 1 wherein the first period of time is no greater than 3 seconds.
 - 9. (Original): The method of claim 1 wherein,

the second feeding occurs at selected chamber deposition pressure and substrate temperature conditions, the first feeding also occurring at the selected second feeding chamber deposition pressure and substrate temperature conditions; and

the first period of time is less than the second period of time.

- 10. (Original): The method of claim 1 wherein the first feeding comprises plasma generation within the chamber.
- 11. (Original): The method of claim 1 wherein the first feeding does not comprise plasma generation within the chamber.

Claims 12-40 (Canceled).

41. (Currently Amended): The method of elaim-12 claim 1 wherein the TiCl₄ and silane are fed to the chamber from separate injection ports during the second feeding.

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42. (Currently Amended): The method of elaim 12 claim 1 wherein the TiCl₄ and silane are mixed prior to feeding to proximate the substrate within the chamber during the second feeding.

Claims 43-46 (Canceled).

47. (Currently Amended): The method of claim-43 claim 1 wherein nothing other than TiCl₄ is fed to the chamber during the first period of time.

Claims 48-53 (Canceled).

54. (New): The method of claim 10 further comprising continuing plasma generation within the chamber from the first feeding through the second feeding.